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040804

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
REQUEST FOR FILING APPLICATION UNDER 37 C.F.R. 1.53(b)
WITHOUT FILING FEE AND/OR WITHOUT EXECUTED INVENTOR'S DECLARATION

22141 U.S. PTO
10/820142

040804

Mail Stop Patent Application

Atty. Dkt. 330-275

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

Date: April 8, 2004

This is a request for filing a new PATENT APPLICATION under Rule 53(b) entitled:

**GLASS FOR WINDOW OF SEMICONDUCTOR PACKAGE, GLASS WINDOW FOR SEMICONDUCTOR PACKAGE,
PROCESS FOR PRODUCTION OF GLASS WINDOW, AND SEMICONDUCTOR PACKAGE**

without a filing fee and/or without an executed inventor's oath/declaration.

This application is made by the below identified inventor(s). Attached hereto are the following papers:

- ☐ Newly executed Declaration, ☐ Copy of Declaration from prior application, ☒ Abstract
☐ Please **delete** the following inventors in the continuation/division/continuation-in-part application:

Deleted persons:

38 pages of specification and claims (including 12 numbered claims), and
sheets of accompanying drawing/s for Figures

☐ Attached is a Power of Attorney.

☒ Priority is hereby claimed under 35 U.S.C. § 119 based on the following foreign applications:

Application Number	Country	Day/Month/Year Filed
2003-105037	JP	09 April 2003

, respectively, the entire content of which is hereby incorporated by reference in this application..

☐ Certified copy(ies) of foreign application(s) is/are attached.

☐ Certified copy(ies) filed on _____ in prior application no. _____ filed _____

☐ This application claims the benefit of Provisional Application No. _____, filed _____, the entire content of which is hereby incorporated by reference in this application.

☐ This application is a ☐ continuation/☐ division/☐ continuation-in-part of Application No. _____, filed _____, the entire content of which is hereby incorporated by reference in this application.

☐ Petition filed in prior application to extend its life to insure co-pendency.

☐ The prior application is assigned to _____

☐ It is hereby requested that the Examiner consider the art cited in the above parent application(s) by applicant and/or the Examiner for the reasons stated therein. A listing of that art is attached, but pursuant to Rule 98(d) copies are not required.

☐ Applicant claims "small entity" status. ☐ "Small entity" statement attached.

☒ Please enter the attached preliminary amendment **prior** to calculation of filing fee:

☐ Also attached: ☐ Information Disclosure Statement; ☐ Non-Publication Request; ☐ Nucleotide and/or Amino Acid Sequence Submission; ☐ Statement deleting Inventor(s) named in prior application; ☐ Other:

1. Inventor: Yoichi HACHITANI Japanese
(first) MI (last) (citizenship)
Residence: (city) Tokyo (state/country) Japan
Mailing Address: c/o HOYA CORPORATION, 7-5, Naka-Ochiai 2-chome, Shinjuku-ku, Tokyo, Japan
(Zip Code) 161-0032

2. Inventor: _____
(first) MI (last) (citizenship)
Residence: (city) _____ (state/country) _____
Mailing Address: _____
(Zip Code) _____

☐ **See attached sheet(s) for additional inventor(s) information!!**

Address all future communications to NIXON & VANDERHYE P.C., 1100 North Glebe Road, 8th Floor, Arlington, VA 22201.

Correspondence Address:

Customer Number:

23117

Telephone: (703) 816-4000

Facsimile: (703) 816-4100

ARC:ecb

NIXON & VANDERHYE P.C.

By Atty: Arthur R. Crawford, Reg. No. 25,327

Signature: _____

